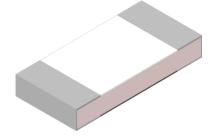


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■ Anti-Surge Low-Resistance Metal Film Chip Resistor — TGL Series



Top view



Bottom view

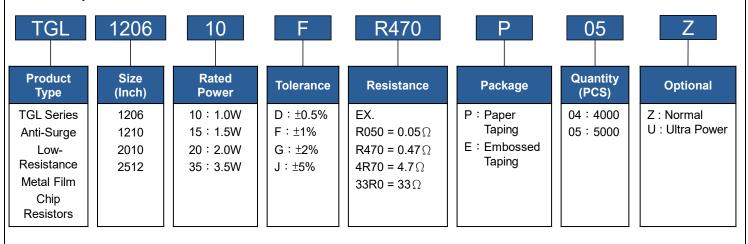
■ Application

- Consumer electronics
- Computer & relative products
- Communication devices
- Measuring instrument
- Industrial / Power supply
- Battery management system

■ Features

- Low Resistance / TCR / Inductance (≤5nH)
- Excellent long-term stability
- High precision current sensing
- High rated power capability and excellent Anti-Surge
- Halogen free and lead free
- RoHs compliant
- AEC-Q200 compliant

■ Parts Number Explanation Example:





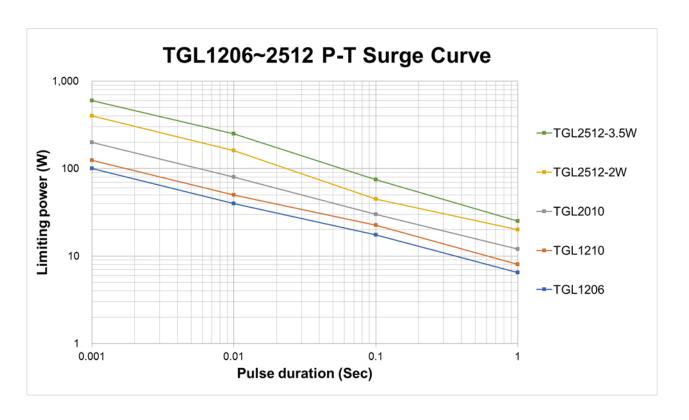
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■ Standard Electrical Specifications

T	Rated Power	Max. Rated	Max. Overload	T.C.R. (ppm/°C)	Resistance Range
Туре	at 70℃	Current	Current		D(0.5%), F(1.0%), G(2.0%), J(5.0%)
TGL1206	1W	4.47A	10.00A	±100	$50 \text{ m}\Omega \leq R < 100 \text{ m}\Omega$
TGL1210	1W	4.47A	10.00A	±50	$100 \text{ m}\Omega \leq \text{R} \leq 33 \Omega$
TGL2010	1.5W	5.48A	12.25A		
TOL 2542	2W	6.32A	14.14A	±50	$50~\text{m}\Omega~\leq~R~\leq~50~\Omega$
TGL2512	3.5W(U)	8.37A	18.71A		

- For non-standard parts, please contact our sales dept.
- Operating Temperature Range : -55° C $\sim +170^{\circ}$ C.

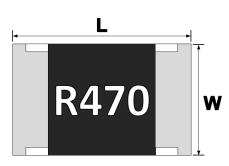
■ Anti-Surge Ability:

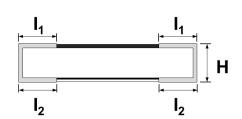




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■ Type Dimension

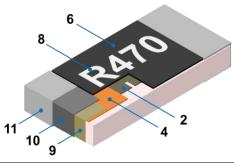


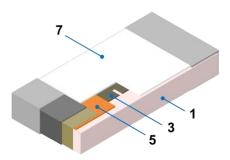


Unit: mm

Туре	L	W	Н	I ₁	l ₂
TGL1206	3.10±0.10	1.60±0.10	0.65±0.15	0.40±0.20	0.45±0.20
TGL1210	3.10±0.10	2.50±0.15	0.65±0.15	0.50±0.20	0.50±0.20
TGL2010	5.00±0.20	2.50±0.15	0.65±0.15	0.60±0.25	0.60±0.25
TGL2512	6.30±0.20	3.20±0.20	0.65±0.15	0.65±0.25	0.65±0.25
TGL2512(U)	6.30±0.20	3.20±0.20	0.75±0.15	0.65±0.25	0.65±0.25

■ Construction





1	Alumina Substrate	7	Bottom Protective Overcoat
2	Top Resistive Layer	8	Marking
3	Bottom Resistive Layer	9	Side Inner Electrode
4	Top Inner Electrode (Cu)	10	Barrier Layer (Ni)
5	Bottom Inner Electrode (Cu)	11	Solder coating (Sn)
6	Top Protective Overcoat		



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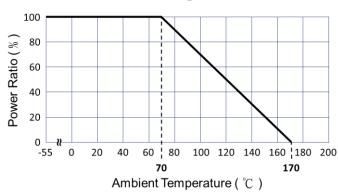
■ Performance Characteristics

■ Power Derating Curve

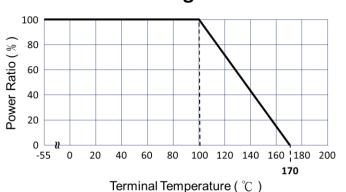
The Operating Temperature Range: -55°C ~+170°C.

Power rating or current rating is in the case based on continuous full-load at ambient temperature of 70°C. For operation at ambient temperature in excess of 70°C, the load should be derated in accordance with figure of derating Curve. (Terminal temperature derating from above 100°C)

Derating Curve



Derating Curve



■ Rated Current

Resistance Range: < 10

Rated Current: The resistor shall have a DC continuous working current or a AC (rms) continuous working current at commercial-line frequency and wave form corresponding to the power rating, as determined formula as following:

I = Rated current (A)
P = Rated power (W)
R = Nominal resistance (Ω)

■ Rated Voltage

Resistance Range: ≥ 10

Rated Voltage: The resistor shall have a DC continuous working voltage or a RMS AC continuous working voltage at commercial-line frequency and wave form corresponding to the power rating, as determined formula as following:

V = Rated voltage (V) $V = \sqrt{P \times R}$ P = Rated power (W) $R = Nominal resistance (\Omega)$



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■ Reliability Test and Requirement

Test Item	Test Method	Procedure	Requirements
Temperature Coefficient of Resistance (T.C.R)	JIS-C-5201-1 4.8 IEC-60115-1 4.8	At 25° / +125 $^{\circ}$, 25° is the reference temperature	Refer to Standard Electrical Specifications
Short Time Overload	JIS-C-5201-1 4.13 IEC-60115-1 4.13	5 times rated power whichever is less for 5 seconds.	±(1.0%+0.001Ω)
Insulation Resistance	JIS-C-5201-1 4.6 IEC-60115-1 4.6	Applied 100VDC for 1 minute.	<u>≥</u> 10GΩ
Dielectric Withstanding Voltage	JIS-C5201-1 4.7	Applied 500VAC for 1 minute.	No short or burned on th appearance.
Core Body Strength	JIS-C5201-1 4.15	Central part pressurizing force : 10N , 10 seconds	No broken
Solderability	JIS-C-5201-1 4.17 IEC-60115-1 4.17	245±5°C for 3 seconds.	>95% Coverage No Visual damage
Resistance to Soldering Heat	JIS-C-5201-1 4.18 IEC-60115-1 4.18	260±5℃ for 10 seconds.	±(1.0%+0.001Ω) No Visual damage
Leaching	JIS-C-5201-1 4.18 IEC-60068-2-58 8.2.1	260±5°C for 30 seconds.	>95% Coverage No Visual damage
Rapid Change of Temperature	JIS-C-5201-1 4.19 IEC-60115-1 4.19	-55℃ to +155℃, 300 cycles	±(1.0%+0.001Ω) No Visual damage
Damp Heat with Load	JIS-C-5201-1 4.24 IEC-60115-1 4.24	$40\pm2^{\circ}$ C, 90~95% R.H. RCWV or Max. working current whichever is less for 1000 hrs with 1.5 hrs "ON" and 0.5 hr "OFF"	±(1.0%+0.001Ω)
Biased Humidity	MIL-STD-202 Method 103	1,000 hours; 85°C / 85% RH, 10% of operating power. Measurement at 24±4 hours after test conclusion.	±(1.0%+0.05Ω)
Load Life (Endurance)	JIS-C-5201-1 4.25 IEC-60115-1 4.25.1	70±2°C, Rated power, or Max. working current whichever is less for 1000 hrs with 1.5 hrs "ON" and 0.5 hr "OFF".	±(1.0%+0.001Ω)
High Temperature Exposure	JIS-C-5201-1 4.23.2 IEC 60068-2-2	At +170±5° for 1000 hours.	±(1.0%+0.001Ω)
Resistance to Solvent	JIS-C-5201-1 4.29	The tested resistor be immersed into isopropyl alcohol of $20{\sim}25^{\circ}\!$	±(1.0%+0.001Ω) No Visual damage
Terminal Strength (SMD)	JIS-C5201-1 4.32 AEC Q200-006	Pressurizing force for 60 seconds 1206 and above: 17.7N	No broken
Bending Strength	JIS-C-5201-1 4.33 IEC-60115-1 4.33	Bending once for 5 seconds D: 1206 \cdot 1210 = 3mm 2010 \cdot 2512 = 2mm	±(1.0%+0.001Ω) No Visual damage

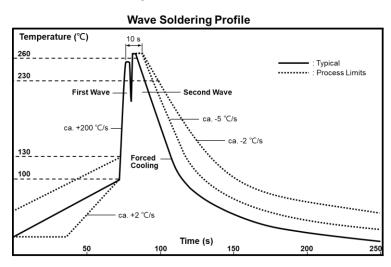
- ullet Temperature Coefficient of Resistance test to 55 $\,^{\circ}\mathrm{C}\,$ is available on request
- We can also provide AEC-Q200 test reports if required by customers.



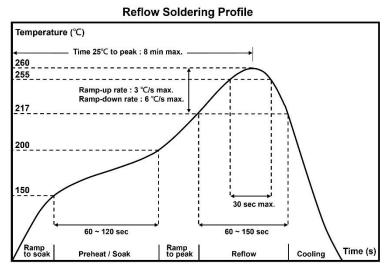
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■ Recommended Customer Soldering Parameters

■ Wave solder Temperature condition



■ Solder reflow Temperature condition



■ Rework temperature (hot air equipment): 350°C, 3~5seconds

■ Recommended reflow methods

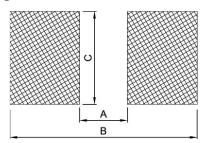
IR, vapor phase oven, hot air oven

If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.



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■ Recommend Land Pattern Design



Unit: mm

Туре	A	В	С
TGL1206	2.20	4.20	1.80
TGL1210	2.00	4.40	2.70
TGL2010	3.80	6.60	2.70
TGL2512	4.90	8.10	3.40

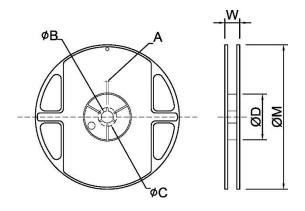
■ Plating Thickness

Ni: $\geq 3 \mu \, \text{m}$

 $Sn(Tin): \ge 3 \mu m$

■ Appendix For SMD Chip Resistor

- Packaging Information
 - **Reel Dimensions**



Unit: mm

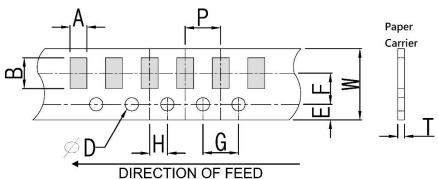
Туре	Size		Α ΦΒ		ΦС	ΦC ΦD		ΦМ
TGL1206	7"	5K/Reel	2.0±0.5	13.5±1.0	21±1.0	60±1.0	11.5±2.0	178±2.0
TGL1210	7"	5K/Reel	2.0±0.5	13.5±1.0	21±1.0	60±1.0	11.5±2.0	178±2.0
TGL2010	7"	4K/Reel	2.0±0.5	13.5±1.0	21±1.0	60±1.0	16.0±2.0	178±2.0
TGL2512	7"	4K/Reel	2.0±0.5	13.5±1.0	21±1.0	60±1.0	16.0±2.0	178±2.0



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■ Packaging Information

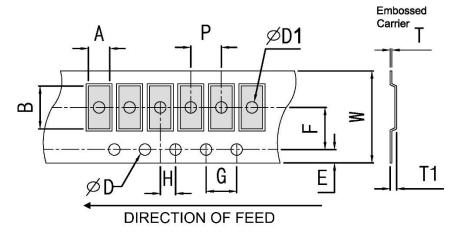
■ Tapping Specifications



Unit: mm

Packaging	Туре	Α	В	W	E	F	G	Н	T	ΦD	Р
D	1206	1.90±0.2	3.05±0.2	8.0±0.2	1.75±0.1	3.5±0.05	4.0±0.1	2.0±0.05	0.75±0.1	1.50+0.1	4.0±0.1
Paper Type	1210	2.85±0.2	3.05±0.2	8.0±0.2	1.75±0.1	3.5±0.05	4.0±0.1	2.0±0.05	0.75±0.1	1.50_0	4.0±0.1

■ Embossed Dimensions



Unit: mm

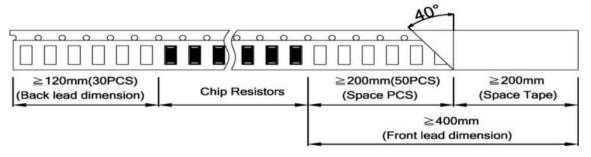
Packaging	Туре	Α	В	W	Ш	F	G	Н	T	ΦD	Φ D1	T1	Р
Embossed	2010	2.80±0.2	5.60±0.2	12±0.1	1.75±0.1	5.5±0.05	4.0±0.1	2.0±0.05	0.23±0.1	1.50+0.1	1.50±0.1	0.85±0.15	4.0±0.1
Туре	2512	3.40±0.2	6.70±0.2	12±0.1	1.75±0.1	5.5±0.05	4.0±0.1	2.0±0.05	0.23±0.1	1.50_6	1.50±0.1	0.85±0.15	4.0±0.1



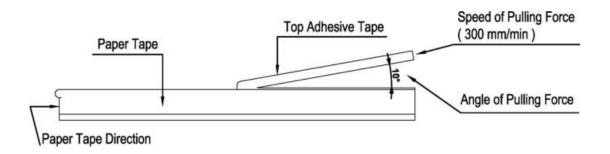
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■ Packing Material Data / Storage Data

■ Front & Back Lead Dimensions

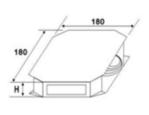


■ Top Adhesive Peel Off Strength: 10~70g

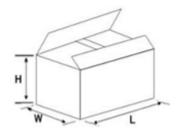


■ Package

Inner Box Size					
Reel	Size H(mm)				
1	13				
2	24				
3	36				
5	60				
10	113				



External Box Size								
Contain (Kpcs)	Length (mm)	Width (mm)	Height (mm)					
25K	180	180	60					
50K	180	180	110					
150K	430	200	200					
300K	400	400	200					



■ Storage Data:

Storage time at the environment temp: 25±5°C& humidity: 60±20% is valid for two years.